







24th IEEE International SoC Conference (SOCC) September 26 – 28, 2011 🔨 Grand Hotel – Taipei, Taiwan, RO

System on Chip (SoC) has been the enabling technology behind the evolution of the volution of the volutions technology, such as Internet, mobile wireless technology, and high definition television. The information technology age, in turn, has fuelled a global communications revolution. SoC devices today include some or all of the major electronics technic gies, comprising RF, analog, optical, digital, and Nano-Electro-Mechanical Systems (NEMS). Recent advances in systems, dep-subricron and nano process technology are unleashing new opportunities, but also creating new challenges. Managements of design and writing fication complexity, EDA tools, on-chip communication, and design reuse for SoCs are significant complications, and SoC fault depation is becoming more difficult as chip size is increasing.

The SOC Conference is a premier forum for sharing advances in SoC echnologies and applications in the areas of digital systems, circuit architectures, design methods, tools, automation, manufacturing, test, and emerging technologies. T 24th SOCC will be held in Taipei, Taiwan, and will offer three days of technical papers, technical workshops, and a vendor exhibition. For updates, please check our website regularly http://www.ieee-socc.org or follow us on twitter "@ieee_socc" (or http://twitter.com/ieee_occ).

SUBMISSION OF PAPER AND WORKSHOP/ TORIAL PROPOSALS

Electronic paper submissions require a full aper in pdf format, limited to six double column EE format pages, and including figures and references. Paper submission deadline in 12011. SOCC 2011 also welcomes embedded to totorial proposals in the related areas of SoC. A proposal with title, a half-page sum hary, and speaker's short bio should be submitter to the Tutorial Chair, Dr. Nagi Naganathan (<u>Nagi.Naganathan@lsi.com</u>), by May 3, 1000. The SOCC proceedings will be published on IEEE *Xplore*[®].

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SOCC TECHNICIL SCOPE

Papers are notice which address new and previously uraublished results in the area of Systems on Chip, and related topics.

- Signal, and Biomedical Circuits and Systems • Anal
- Wireline and Wireless Communication Circuits and Systems
- Digital Signal Processing (DSP) Circuits and Systems (Video, Multimedia, Software-Defined Radio, etc.)
- Green Circuits, Systems, and Design Methodologies
- Embedded Systems, Multi/Many Core Systems and Embedded Memory Technologies
- Network on Chip (NoC), Interconnects, and 3D-IC
- Reconfigurable and Programmable Circuits and Systems, System on Programmable Devices (FPGAs)
- System Level Design Methodology, EDA and Design Tools for SoC
- Signal Integrity, Design for Testability, and Design Verification
- Design for Manufacturability, Variation-Aware Methodologies

IMPORTANT DATES

Paper submission deadline V	•	: Ma , 2011
Notification of acceptance:		June 13, 2011
Final camera-ready paper due:		July 11, 2011

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